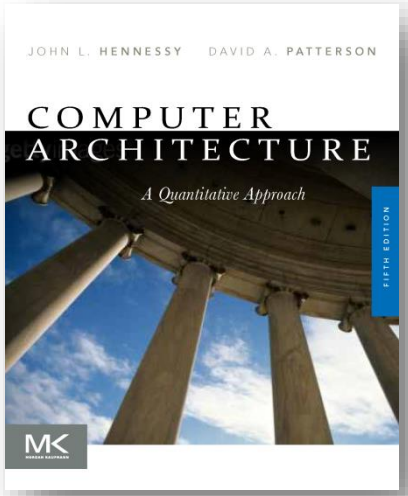

Chapter 1

Fundamentals of Quantitative Design and Analysis

Based on and extended from lecture note provided by publisher

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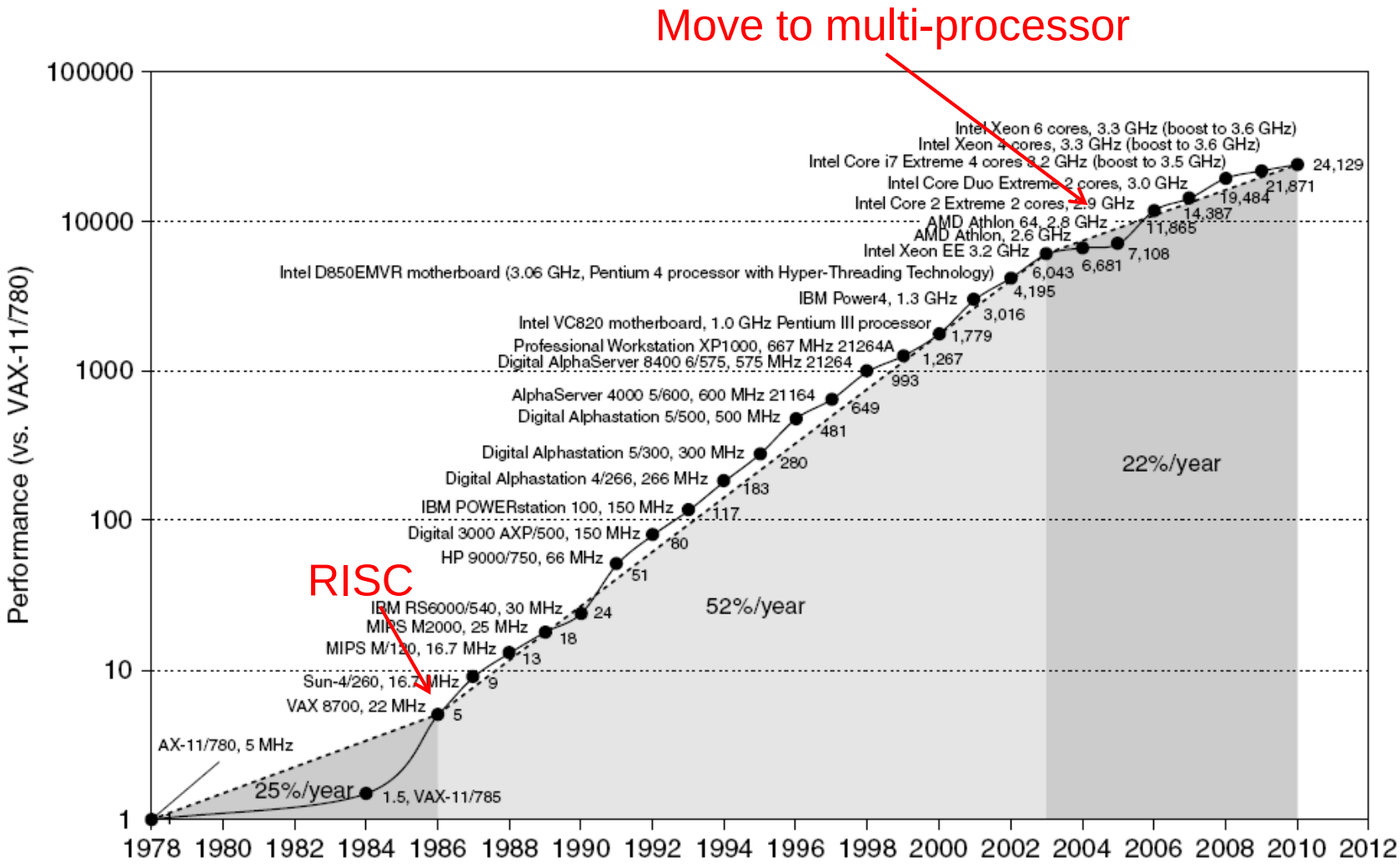
Computer Technology

- Performance improvements:
  - Improvements in semiconductor technology
    - Feature size, clock speed
  - Improvements in computer architectures
    - Enabled by HLL compilers, UNIX
    - Lead to RISC architectures
  - Together have enabled:
    - Lightweight computers
    - Productivity-based managed/interpreted programming languages

Single Processor Performance



Current Trends in Architecture

- Cannot continue to exploit Instruction-Level parallelism (ILP)
  - Single processor performance improvement ended in 2003
- New models for performance:
  - Data-level parallelism (DLP)
  - Thread-level parallelism (TLP)
  - Request-level parallelism (RLP)
  - These require explicit restructuring of applications

Classes of Computers

- Personal Mobile Device (PMD)
  - e.g. smart phones, tablet computers
  - Emphasis on energy efficiency and real-time for media apps
- Desktop Computing
  - Emphasis on price-performance
- Servers
  - Emphasis on availability, scalability, throughput
- Clusters / Warehouse Scale Computers
  - Used for “Software as a Service (SaaS)”
  - Emphasis on availability and price-performance
  - Sub-class: Supercomputers, emphasis: floating-point performance and fast internal networks
- Embedded Computers
  - Microwaves, washing machines, printers, networking switches
  - Emphasis: price

Classes of Computers (cont'd)

Feature	Personal mobile device (PMD)	Desktop	Server	Clusters/warehouse-scale computer	Embedded
Price of system	$100–$1000	$300–$2500	$5000–$10,000,000	$100,000–$200,000,000	$10–$100,000
Price of micro-processor	$10–$100	$50–$500	$200–$2000	$50–$250	$0.01–$100
Critical system design issues	Cost, energy, media performance, responsiveness	Price-performance, energy, graphics performance	Throughput, availability, scalability, energy	Price-performance, throughput, energy proportionality	Price, energy, application-specific performance

Figure 1.2 A summary of the five mainstream computing classes and their system characteristics. Sales in 2010 included about 1.8 billion PMDs (90% cell phones), 350 million desktop PCs, and 20 million servers. The total number of embedded processors sold was nearly 19 billion. In total, 6.1 billion ARM-technology based chips were shipped in 2010. Note the wide range in system price for servers and embedded systems, which go from USB keys to network routers. For servers, this range arises from the need for very large-scale multiprocessor systems for high-end transaction processing.

Parallelism

- Classes of parallelism in applications:
  - Data-Level Parallelism (DLP) many data items that can be operated on at the same time
  - Task-Level Parallelism (TLP) tasks of work are created that can operate independently and largely in parallel

- Classes of architectural parallelism:
  - Instruction-Level Parallelism (ILP)
    - Exploit DLP
  - Vector architectures/Graphic Processor Units (GPUs)
    - Exploit DLP apply a single instruction to a coolection of data in parallel
  - Thread-Level Parallelism
    - Exploit DLP or TLP
  - Request-Level Parallelism
    - Exploit TLP largely decoupled task specified by the programmer or the operating system

Flynn's Taxonomy

- Single instruction stream, single data stream (SISD)

  uniprocessor
  exploit : instruction level parallelism

- Single instruction stream, multiple data streams (SIMD)
  - Vector architectures
  - Multimedia extensions
  - Graphics processor units

- Multiple instruction streams, single data stream (MISD)
  - No commercial implementation

- Multiple instruction streams, multiple data streams (MIMD)
  - Tightly-coupled MIMD — exploit thread-level parallelism since multiple cooperating threads operate in parallel
  - Loosely-coupled MIMD — clusters and warehouse-scale computer that exploit request-level parallelism where many independent tasks can proceed in parallel naturally with little need for communication or synchronization

Defining Computer Architecture

- "Old" view of computer architecture:
  - Instruction Set Architecture (ISA) design
  - i.e. decisions regarding:
    - registers, memory addressing, addressing modes, instruction operands, available operations, control flow instructions, instruction encoding

class of ISA
Nealry all ISAs today are classified as general-purpose register architectures (operands are either registers or memory locations)
two popular version
1. register-memory ISAs : x86 , which can access memory as part of many instructions
2. load-store ISAS : ARM and MIPS, which can access memory only with load or store instructions

- "Real" computer architecture:
  - Meet specific functional requirements of the target machine
  - Design to maximize performance within constraints: cost, power, and availability
  - Includes ISA, microarchitecture, hardware

MIPS registers

Name	Number	Use	Preserved across a call?
$zero	0	The constant value 0	N.A.
$at	1	Assembler temporary	No
$v0–$v1	2–3	Values for function results and expression evaluation	No
$a0–$a3	4–7	Arguments	No
$t0–$t7	8–15	Temporaries	No
$s0–$s7	16–23	Saved temporaries	Yes
$t8–$t9	24–25	Temporaries	No
$k0–$k1	26–27	Reserved for OS kernel	No
$gp	28	Global pointer	Yes
$sp	29	Stack pointer	Yes
$fp	30	Frame pointer	Yes
$ra	31	Return address	Yes

Figure 1.4 MIPS registers and usage conventions. In addition to the 32 general-purpose registers (R0–R31), MIPS has 32 floating-point registers (F0–F31) that can hold either a 32-bit single-precision number or a 64-bit double-precision number.

MIPS64 instructions

Instruction type/opcode	Instruction meaning
Data transfers	*Move data between registers and memory, or between the integer and FP or special registers; only memory address mode is 16-bit displacement + contents of a GPR*
LB, LBU, SB	Load byte, load byte unsigned, store byte (to/from integer registers)
LH, LHU, SH	Load half word, load half word unsigned, store half word (to/from integer registers)
LW, LWU, SW	Load word, load word unsigned, store word (to/from integer registers)
LD, SD	Load double word, store double word (to/from integer registers)
L.S, L.D, S.S, S.D	Load SP float, load DP float, store SP float, store DP float
MFC0, MTC0	Copy from/to GPR to/from a special register
MOV.S, MOV.D	Copy one SP or DP FP register to another FP register
MFC1, MTC1	Copy 32 bits to/from FP registers from/to integer registers
Arithmetic/logical	*Operations on integer or logical data in GPRs; signed arithmetic trap on overflow*
DADD, DADDI, DADDU, DADDIU	Add, add immediate (all immediates are 16 bits); signed and unsigned
DSUB, DSUBU	Subtract, signed and unsigned
DMUL, DMULU, DDIV, DDIVU, MADD	Multiply and divide, signed and unsigned; multiply-add; all operations take and yield 64-bit values
AND, ANDI	And, and immediate
OR, ORI, XOR, XORI	Or, or immediate, exclusive or, exclusive or immediate
LUI	Load upper immediate; loads bits 32 to 47 of register with immediate, then sign-extends
DSLL, DSRL, DSRA, DSLLV, DSRLV, DSRAV	Shifts: both immediate (DS__) and variable form (DS__V); shifts are shift left logical, right logical, right arithmetic
SLT, SLTI, SLTU, SLTIU	Set less than, set less than immediate, signed and unsigned
Control	*Conditional branches and jumps; PC-relative or through register*
BEQZ, BNEZ	Branch GPRs equal/not equal to zero; 16-bit offset from PC + 4
BEQ, BNE	Branch GPR equal/not equal; 16-bit offset from PC + 4
BC1T, BC1F	Test comparison bit in the FP status register and branch; 16-bit offset from PC + 4
MOVN, MOVZ	Copy GPR to another GPR if third GPR is negative, zero
J, JR	Jumps: 26-bit offset from PC + 4 (J) or target in register (JR)
JAL, JALR	Jump and link: save PC + 4 in R31, target is PC-relative (JAL) or a register (JALR)
TRAP	Transfer to operating system at a vectored address
ERET	Return to user code from an exception; restore user mode
Floating point	*FP operations on DP and SP formats*
ADD.D, ADD.S, ADD.PS	Add DP, SP numbers, and pairs of SP numbers
SUB.D, SUB.S, SUB.PS	Subtract DP, SP numbers, and pairs of SP numbers
MUL.D, MUL.S, MUL.PS	Multiply DP, SP floating point, and pairs of SP numbers
MADD.D, MADD.S, MADD.PS	Multiply-add DP, SP numbers, and pairs of SP numbers
DIV.D, DIV.S, DIV.PS	Divide DP, SP floating point, and pairs of SP numbers
CVT._._	Convert instructions: CVT.x.y converts from type x to type y, where x and y are L (64-bit integer), W (32-bit integer), D (DP), or S (SP). Both operands are FPRs.
C.__.D, C.__.S	DP and SP compares: "__" = LT,GT,LE,GE,EQ,NE; sets bit in FP status register

Figure 1.5 Subset of the instructions in MIPS64. SP = single precision; DP = double precision. Appendix A gives much more detail on MIPS64. For data, the most significant bit number is 0; least is 63.

MPIS64 instruction formats

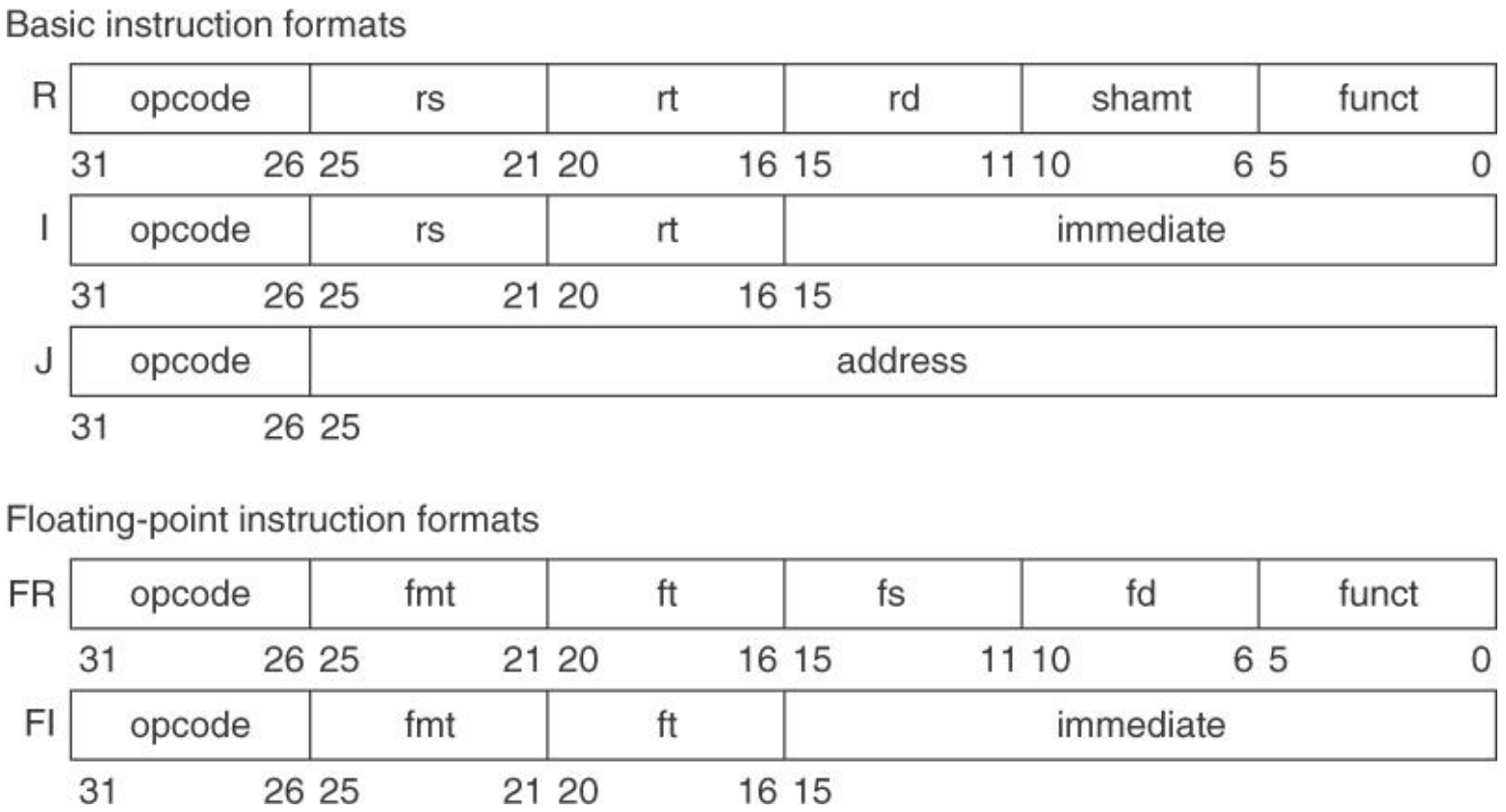


Figure 1.6 MIPS64 instruction set architecture formats. All instructions are 32 bits long. The R format is for integer register-to-register operations, such as DADDU, DSUBU, and so on. The I format is for data transfers, branches, and immediate instructions, such as LD, SD, BEQZ, and DADDIs. The J format is for jumps, the FR format for floating-point operations, and the FI format for floating-point branches.

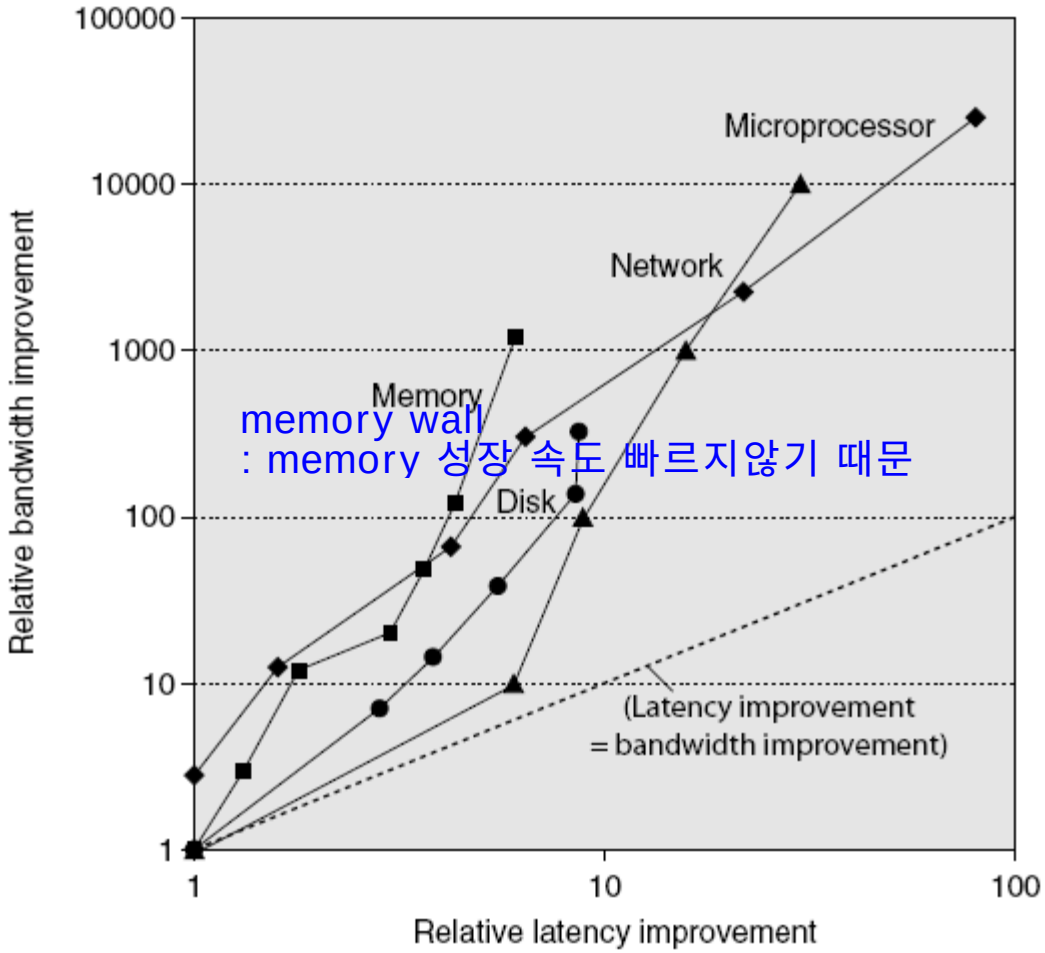
Trends in Technology

- Integrated circuit technology
  - Transistor density: 35%/year
  - Integration overall: 40-55%/year
    - Moore's law
- DRAM capacity: 25-40%/year (slowing)
- Flash capacity: 50-60%/year
  - 15-20X cheaper/bit than DRAM
- Magnetic disk technology: 40%/year
  - 15-25X cheaper/bit than Flash
  - 300-500X cheaper/bit than DRAM

Bandwidth and Latency

- Bandwidth or throughput
  - Total work done in a given time
  - 10,000-25,000X improvement for processors
  - 300-1200X improvement for memory and disks
- Latency or response time
  - Time between start and completion of an event
  - 30-80X improvement for processors
  - 6-8X improvement for memory and disks

Bandwidth and Latency



Log-log plot of bandwidth and latency milestones

Transistors and Wires

- Feature size
  - Minimum size of transistor or wire in x or y dimension
  - 10 microns in 1971 to .032 microns in 2011

32 nano

  - Transistor performance scales linearly
    - Wire delay does not improve with feature size!

latency though wire does not improve

  - Integration density scales quadratically

면적이기때문에 quadratically 감소

transistor performance : as feature sizes shrink, devices shrink quadratically in the horizontal dimension and also shrink in the vertical dimension. the shrink in the vertical dimension requires a reduction in operating voltage to maintain correct operation and reliability of the transisotor. this combination of scaling factors leads to a complex interrelationship between transistor performance and process feature size

wire delay : the signal delay for a wire increases in proportion to the product of its resistance and capacitance. of course as feature size shrinks, wires get shorter, but the resistance and capacitance per unit length get worse. this relationship is complex, since both resistance and capacitance depend on detailed aspects of the process, the geometry of a wire, the loading on a wire, and even the adjacency to other structures.